



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

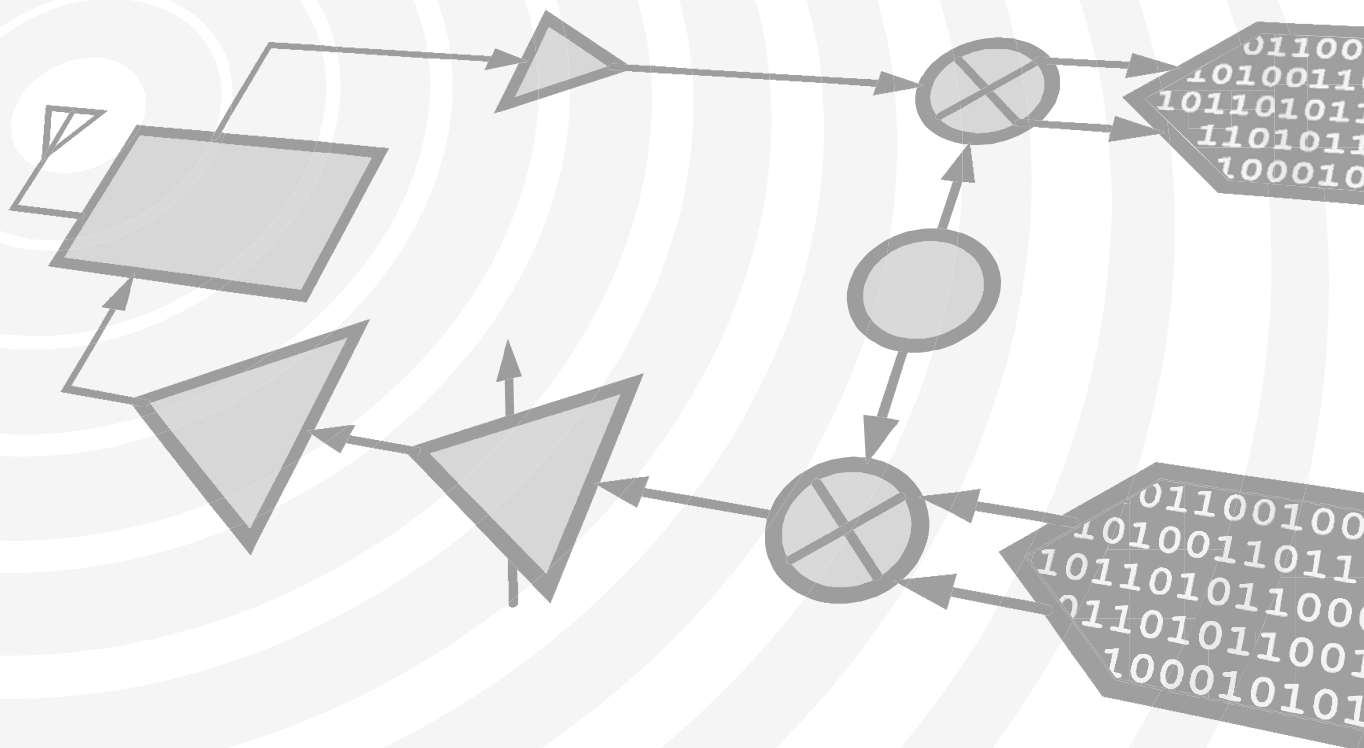
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



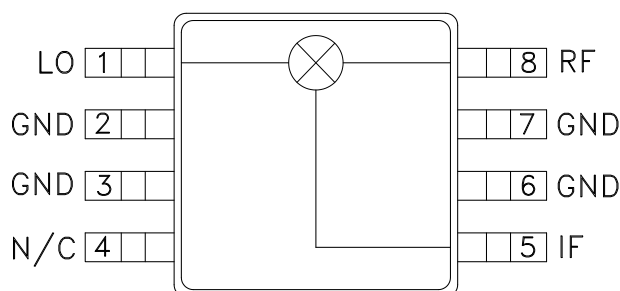
THIS PAGE INTENTIONALLY LEFT BLANK

Typical Applications

The HMC218AMS8E is ideal for:

- Basestations, Repeaters & Access Points
- WiMAX, WiBro & Fixed Wireless
- Portables & Subscribers
- PLMR, Public Safety & Telematics

Functional Diagram



Features

- Passive Double-Balanced Topology
- Input IP3: +18 dBm
- Low Conversion Loss: 6.5 dB
- LO / RF Isolation: 30 dB
- LO / IF Isolation: 25 dB
- Upconverter & Downconverter Applications

General Description

The HMC218AMS8E is an ultra miniature double-balanced mixer in an 8 lead plastic surface mount package (MSOP). This passive MMIC mixer is constructed of GaAs Schottky diodes and novel planar transformer baluns on the chip. The device can be used as an upconverter, downconverter, biphas modulator / demodulator, or phase comparator. The low conversion loss, high isolation and wide IF bandwidth make this mixer ideal for a variety of Rx and Tx frequency plans.

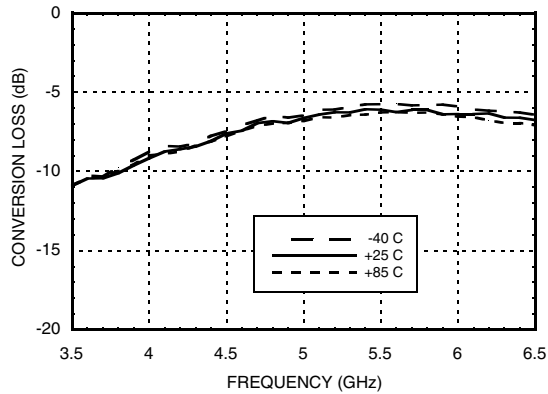
Electrical Specifications, $T_A = +25^\circ \text{C}$, As a Function of LO Drive

Parameter	LO = +13 dBm IF = 100 MHz			LO = +10 dBm IF = 100 MHz			LO = +7 dBm IF = 100 MHz			Units
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range, RF & LO	4.5 - 6.0			4.5 - 6.0			4.7 - 5.9			GHz
Frequency Range, IF	DC - 1.6			DC - 1.6			DC - 1.5			GHz
Conversion Loss		6.5	8.5		8	9.5		8	9.5	dB
Noise Figure (SSB)		6.5	8.5		8	9.5		8	9.5	dB
LO to RF Isolation	25	30		25	30		23	28		dB
LO to IF Isolation	15	25		14	25		12	23		dB
IP3 (Input)	5.2 GHz	12	16	11	14		9	12		dBm
	5.8 GHz	15	18	13	17		10	13		
1 dB Gain Compression (Input)	7	10		5	9		4	7		dBm

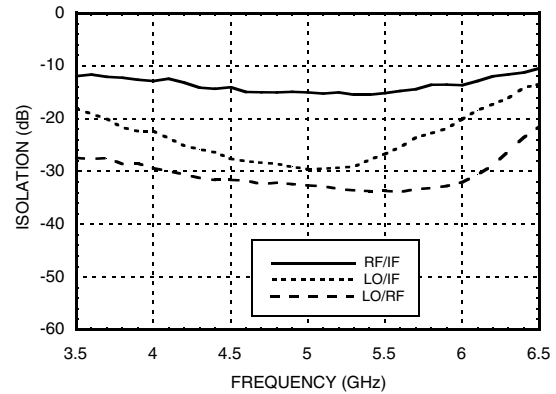


GaAs MMIC SMT DOUBLE-BALANCED MIXER, 4.5 - 6 GHz

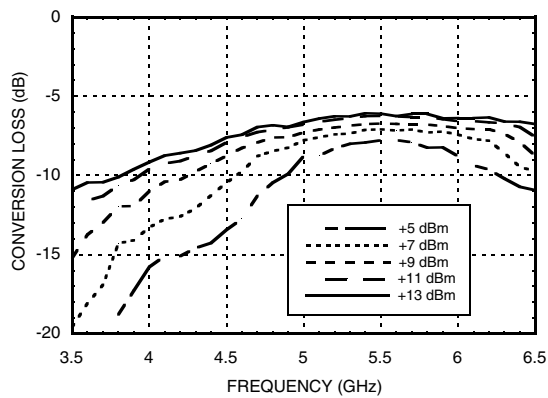
Conversion Loss vs Temperature @ LO = +13 dBm



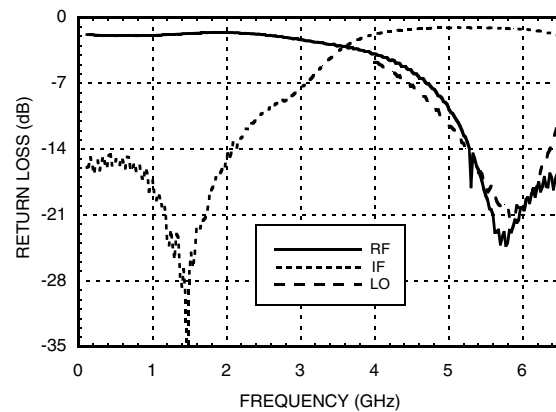
Isolation @ LO = +13 dBm



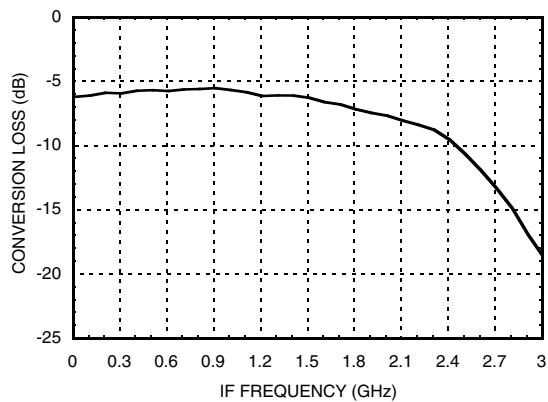
Conversion Loss vs. LO Drive



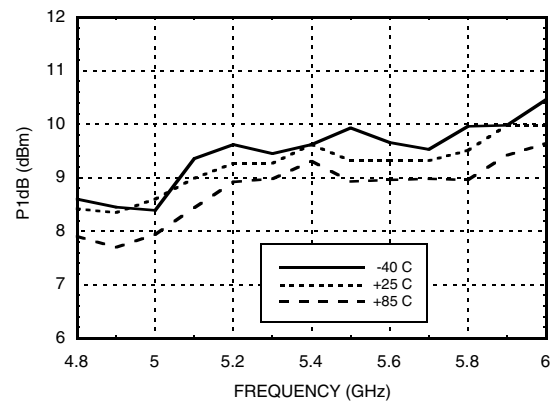
Return Loss @ LO = +13 dBm

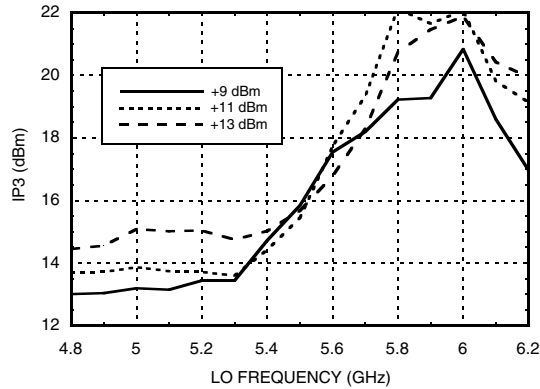
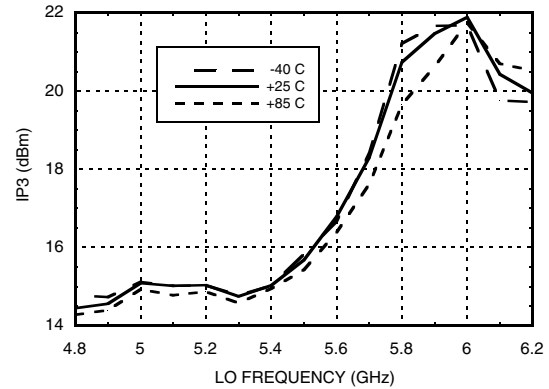
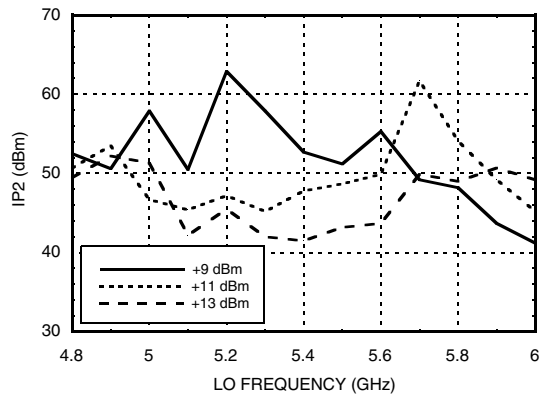
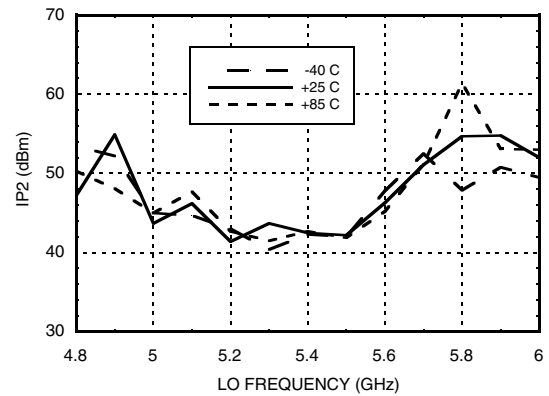


IF Bandwidth @ LO = +13 dBm



P1dB vs. Temperature @ LO = +13 dBm



GaAs MMIC SMT DOUBLE-BALANCED MIXER, 4.5 - 6 GHz
Input IP3 vs. LO Drive

Input IP3 vs. Temperature @ LO = +13 dBm

Input IP2 vs. LO Drive

Input IP2 vs. Temperature @ LO = +13 dBm



GaAs MMIC SMT DOUBLE-BALANCED MIXER, 4.5 - 6 GHz
MxN Spurious Outputs

mRF	nLO				
	0	1	2	3	4
0	xx	1	10	22	35
1	8	0	37	29	54
2	67	60	58	58	77
3	>85	79	79	59	77
4	>85	>85	>85	>85	>85

RF = 5.15 GHz @ -10 dBm
 LO = 5.25 GHz @ +13 dBm
 All values in dBc relative to the IF

Harmonics of LO

LO Freq. (GHz)	nLO Spur at RF Port			
	1	2	3	4
5.0	32	26	50	69
5.2	32	28	55	71
5.4	33	32	54	75
5.6	33	33	55	69
5.8	33	32	56	62
6.0	32	34	57	58

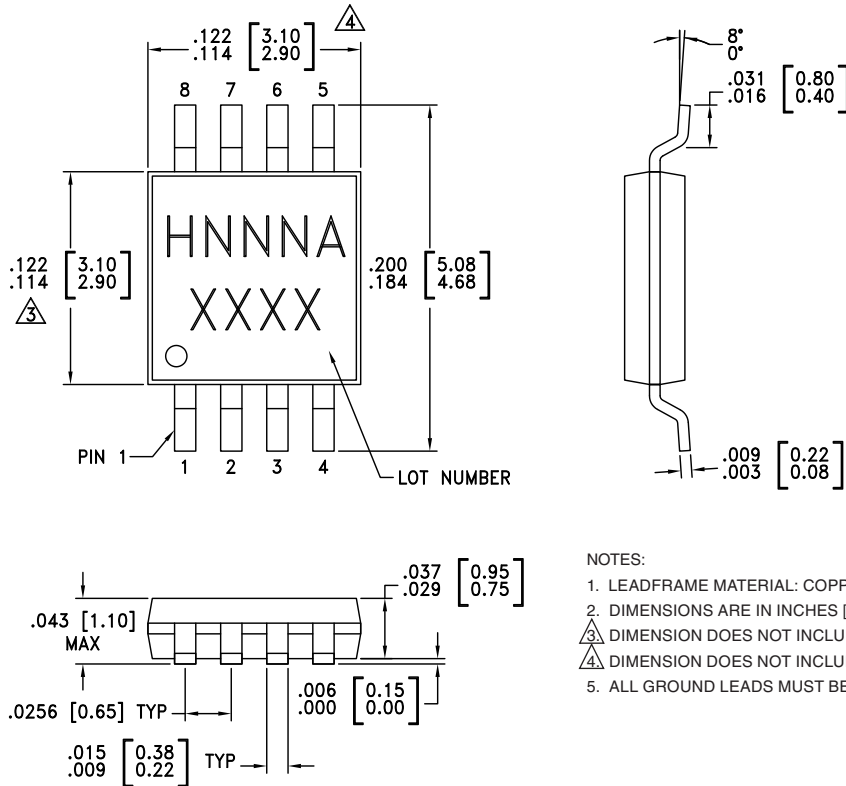
LO = +13 dBm
 Values in dBc below LO level measured at RF Port.

Absolute Maximum Ratings

RF / Input	+13 dBm
LO Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C



**ELECTROSTATIC SENSITIVE DEVICE
 OBSERVE HANDLING PRECAUTIONS**

Outline Drawing

NOTES:

- LEADFRAME MATERIAL: COPPER ALLOY
- DIMENSIONS ARE IN INCHES [MILLIMETERS]
- \triangle DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15 mm PER SIDE.
- \triangle DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25 mm PER SIDE.
- ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC218AMS8E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[1]	H218A XXXX

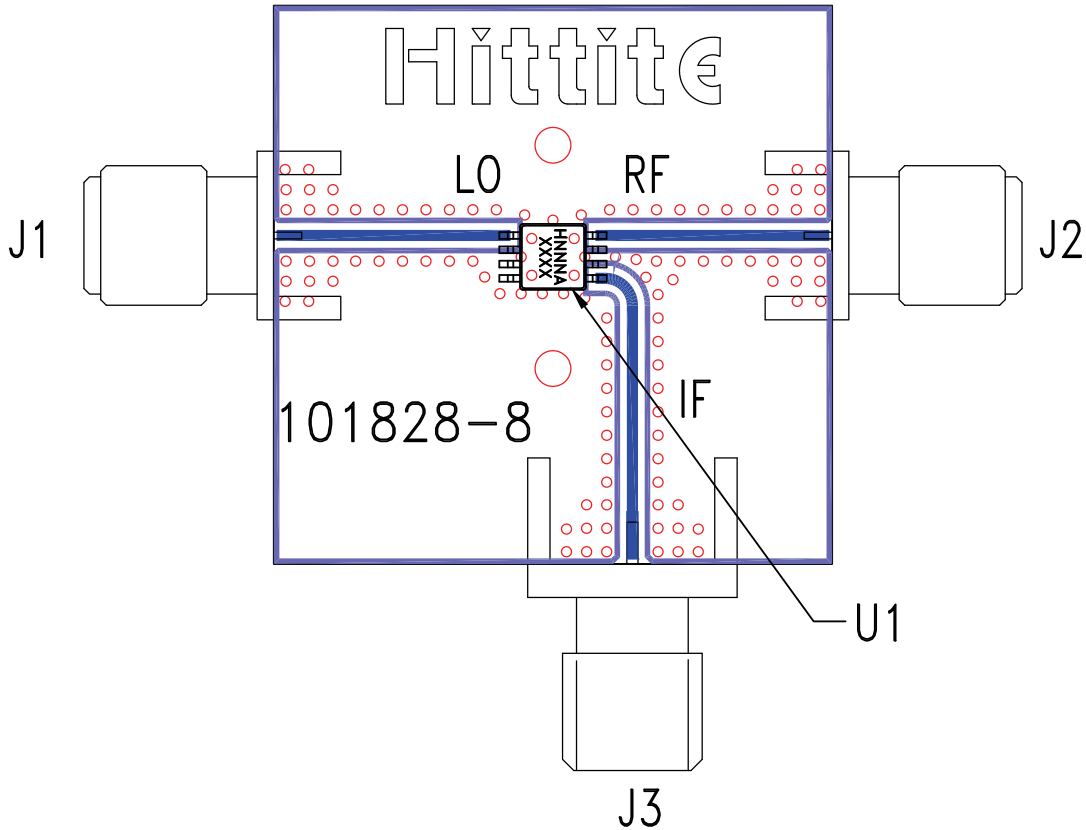
[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX



GaAs MMIC SMT DOUBLE-BALANCED MIXER, 4.5 - 6 GHz

Evaluation PCB



List of Materials for Evaluation PCB 101830 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC218AMS8E Mixer
PCB [2]	101828 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.